

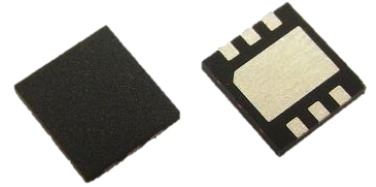
### FEATURES

- High Voltage Operation :  $V_{DS}=50V$
- High Power : 41dBm (typ.) @  $P_{sat}$
- High Efficiency : 60% (typ.) @  $P_{sat}$
- Power Gain : 19.5dB (typ.) @  $f=2.65GHz$
- Proven Reliability

### DESCRIPTION

Sumitomo's GaN-HEMT offers high efficiency, ease of matching, greater consistency and broad bandwidth for high power amplifiers with 50V operation, and gives you higher gain.

This new product is ideally suited for use up to 3.8GHz W-CDMA & LTE design requirements as it offers high gain, long term reliability and ease of use. This device target applications are driver stage and final stage of micro cell base transceiver stations.



### ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Condition	Rating	Unit
Operating Voltage	$V_{DS}$		55	V
Drain-Source Voltage	$V_{DS}^*$	$V_{GS}=-8V$	160	V
Gate-Source Voltage	$V_{GS}^*$		-15	V
Total Power Dissipation	$P_t^*$		13.5	W
Storage Temperature	Tstg		-40 to +125	deg.C
Channel Temperature	Tch		250	deg.C

\* : Case Temperature  $T_c=25deg.C$

### RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
DC Input Voltage	$V_{DS}$		$\leq 55$	V
Forward Gate Current	IGF	$RG=51ohm$	$\leq 23$	mA
Reverse Gate Current	IGR	$RG=51ohm$	$\geq -0.3$	mA
Channel Temperature	Tch		$\leq 200$	deg.C
Average Output Power	Pave.		$\leq 38.0$	dBm

### ELECTRICAL CHARACTERISTICS ( Case Temperature $T_c=25deg.C$ )

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-Off Voltage	$V_p$	$V_{DS}=50V, I_{DS}=2.7mA$	-1.0	-1.5	-2.0	V
Saturated Power	$P_{sat}^*1$	$V_{DS}=50V,$ $I_{DS}(DC)\approx 0mA$ $f=2.65GHz$	40.0	41.0	-	dBm
Drain Efficiency	$DE^*2$	$V_{DS}=50V$	11.5	13.5	-	%
Power Gain	$G_p^*2$	$I_{DS}(DC)\approx 50mA$ $f=2.65GHz$	18.5	19.5	-	dB
Thermal Resistance	$R_{th}^*3$	Channel to Case at 12W PDC	-	10.0	11.5	deg.C/W

Note : \*1 : 10%-duty RF pulse ( DC supply constant )

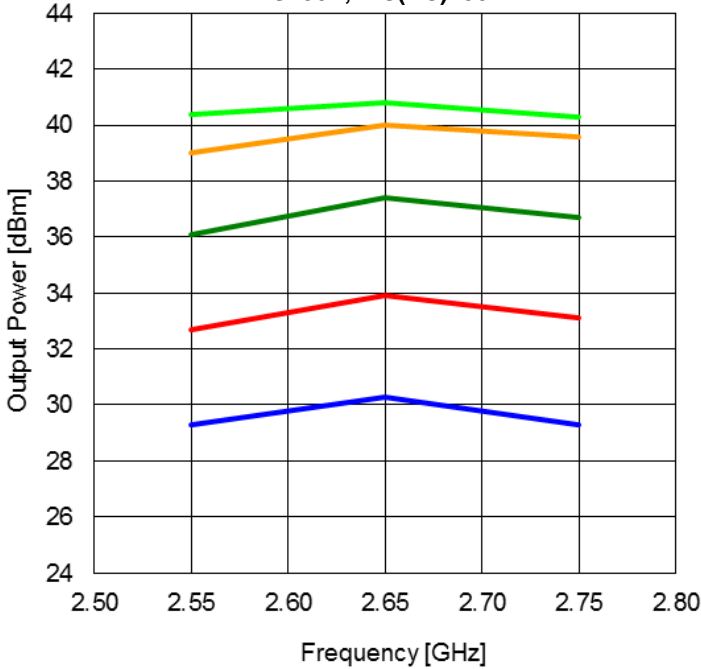
\*2 :  $P_{out}=27.5dBm$ , CW modulation Signal ( W-CDMA )

\*3 : Sampling Test : samples size 10pcs. Criteria(accept / reject)=(0 / 1)

RoHS COMPLIANCE Yes

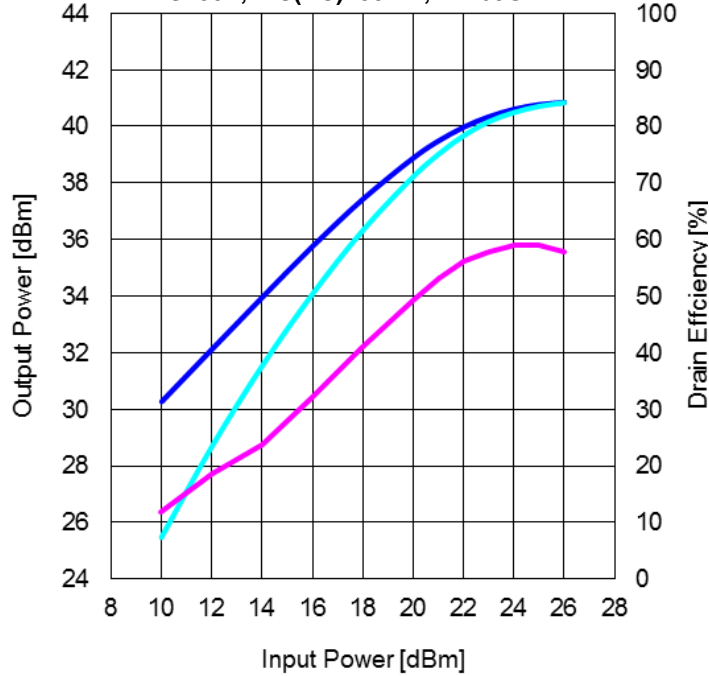
**RF characteristics @f=2.65GHz fine tuned**

**Output Power vs. Frequency**  
VDS=50V, IDS(DC)=50mA



— Pin=10dBm    — Pin=14dBm    — Pin=18dBm  
— Pin=22dBm    — Pin=26dBm

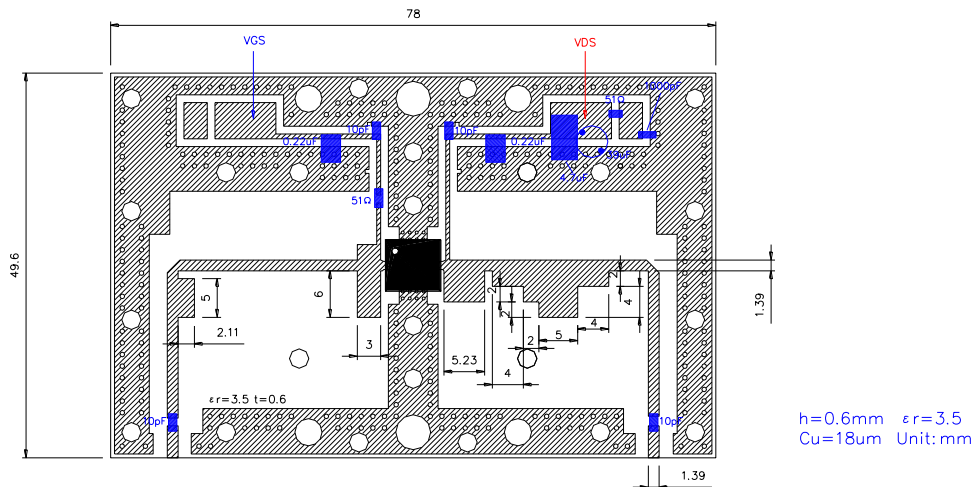
**Output Power and Drain Efficiency vs. Input Power**  
VDS=50V, IDS(DC)=50mA, f=2.65GHz



— Pout (class AB)    — Pout (class B)    — DE (class B)

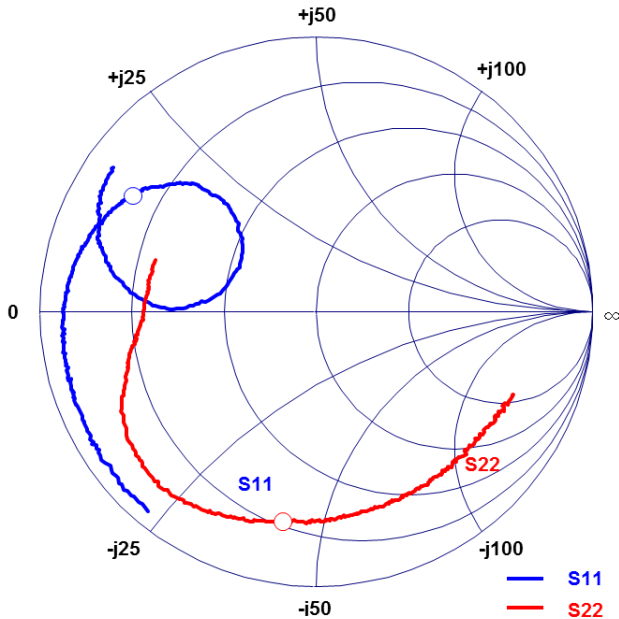
**Test Fixture**

**Pulse Signal (10%-duty, DC : constant)**

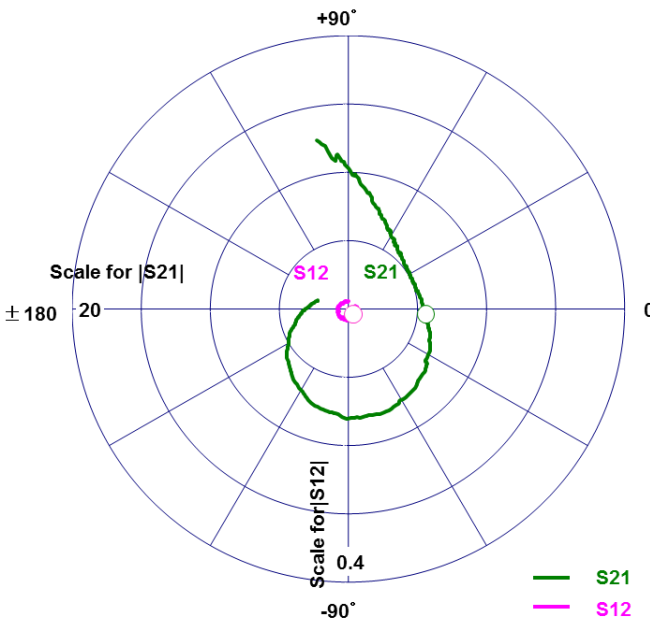


S-Parameters @VDS=50V, IDS(DC)=50mA, f=0.5 to 4.5GHz  
 ZI = Zs = 50ohm      Marker : 2.65GHz

**- Reference DATA -**



Freq. GHz	S11			S21		S12		S22	
	MAG	ANG		MAG	ANG	MAG	ANG	MAG	ANG
0.5	0.95	-129.93	12.58	100.49	0.011	28.60	0.77	-22.89	
0.6	0.94	-139.93	10.90	92.90	0.012	8.88	0.76	-26.00	
0.7	0.93	-147.32	9.75	86.55	0.010	9.98	0.76	-29.84	
0.8	0.93	-153.24	8.63	80.91	0.011	3.22	0.75	-32.91	
0.9	0.93	-158.83	7.94	76.82	0.012	5.31	0.75	-35.81	
1.0	0.93	-162.89	7.31	72.03	0.010	-2.88	0.74	-39.01	
1.1	0.93	-166.82	6.88	67.41	0.010	-6.63	0.74	-42.92	
1.2	0.92	-170.50	6.48	62.59	0.011	-4.70	0.74	-46.13	
1.3	0.92	-173.92	6.12	57.97	0.010	-10.91	0.74	-49.89	
1.4	0.92	-177.21	5.82	54.41	0.010	-8.83	0.74	-52.97	
1.5	0.92	-179.73	5.60	50.55	0.010	-11.20	0.74	-56.43	
1.6	0.91	177.77	5.47	46.29	0.010	-15.35	0.74	-60.46	
1.7	0.90	175.05	5.35	41.47	0.010	-15.16	0.74	-63.58	
1.8	0.90	171.96	5.22	37.55	0.010	-25.32	0.74	-67.64	
1.9	0.89	169.48	5.14	33.16	0.011	-27.51	0.75	-70.65	
2.0	0.89	166.66	5.10	29.06	0.009	-28.32	0.75	-74.61	
2.1	0.87	164.09	5.07	24.37	0.009	-31.76	0.75	-78.62	
2.2	0.87	161.09	5.16	19.61	0.010	-28.63	0.75	-82.05	
2.3	0.85	158.26	5.18	14.77	0.010	-33.80	0.76	-85.63	
2.4	0.84	155.74	5.22	10.05	0.011	-39.35	0.76	-89.55	
2.5	0.82	152.57	5.35	4.78	0.011	-43.81	0.77	-93.43	
2.6	0.80	149.29	5.52	-0.67	0.012	-44.46	0.77	-96.84	
2.7	0.77	145.30	5.76	-7.17	0.012	-48.98	0.78	-100.93	
2.8	0.75	142.65	5.99	-13.89	0.012	-53.11	0.79	-104.93	
2.9	0.70	138.52	6.32	-21.78	0.012	-58.62	0.80	-109.14	
3.0	0.65	134.48	6.70	-29.82	0.015	-64.80	0.82	-114.06	
3.1	0.58	131.80	7.14	-38.89	0.015	-73.40	0.83	-118.67	
3.2	0.50	129.47	7.52	-50.19	0.016	-85.87	0.84	-124.99	
3.3	0.41	133.84	7.86	-62.79	0.015	-96.18	0.85	-131.14	
3.4	0.33	144.39	7.91	-78.91	0.016	-111.28	0.84	-138.75	
3.5	0.34	162.93	7.90	-93.35	0.016	-129.03	0.83	-145.71	
3.6	0.43	176.07	7.53	-107.26	0.017	-145.72	0.79	-152.74	
3.7	0.54	178.95	6.81	-121.37	0.017	-163.59	0.74	-158.90	
3.8	0.64	175.75	6.04	-134.54	0.015	-179.75	0.71	-164.16	
3.9	0.73	170.46	5.23	-147.15	0.014	170.23	0.68	-169.36	
4.0	0.78	165.99	4.58	-157.41	0.013	150.22	0.65	-173.92	
4.1	0.83	161.90	3.96	-165.60	0.013	139.85	0.63	-178.26	
4.2	0.86	155.92	3.45	-174.11	0.012	124.46	0.62	-177.42	
4.3	0.88	152.82	2.97	-178.69	0.012	116.26	0.61	-173.04	
4.4	0.89	149.73	2.61	-170.76	0.011	109.13	0.61	-167.98	
4.5	0.90	144.53	2.29	-164.51	0.011	89.46	0.61	-162.12	



**ESD characteristic**

Test Methodology	Class
Human Body Model (per JESD22-A114)	1C
Machine Model (per JESD22-A115)	A
Charged-Device Model (per JESD22-C101)	C3

**Ordering Information**

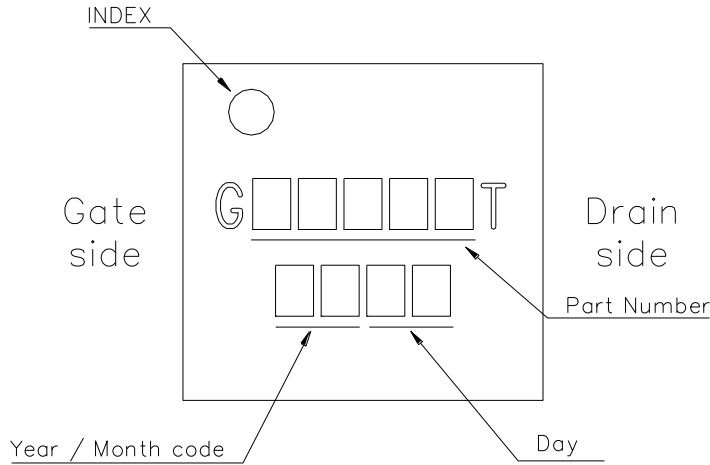
Part Number	MOQ	MOU	Packing Style
SGFCF20T-DT	2500pcs.	2500pcs.	Tape and Reel (16mm width Tape)
SGFCF20T-DT1	500pcs.	500pcs.	Tape and Reel (16mm width Tape)
SGFCF20T-D	20pcs.	20pcs.	Tray (4-inch)

Note : \*MOQ stands for Minimum Order Quantity.  
\*MOU stands for Minimum Order Unit size.

**Moisture Sensitivity Level**

Level	Floor Life	
	Time	Condition
2a	4weeks after open the package	≤30deg.C/60%RH

**Package Markings**



**Year code**

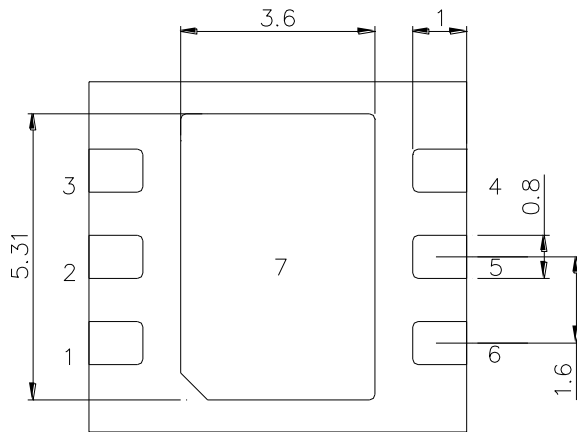
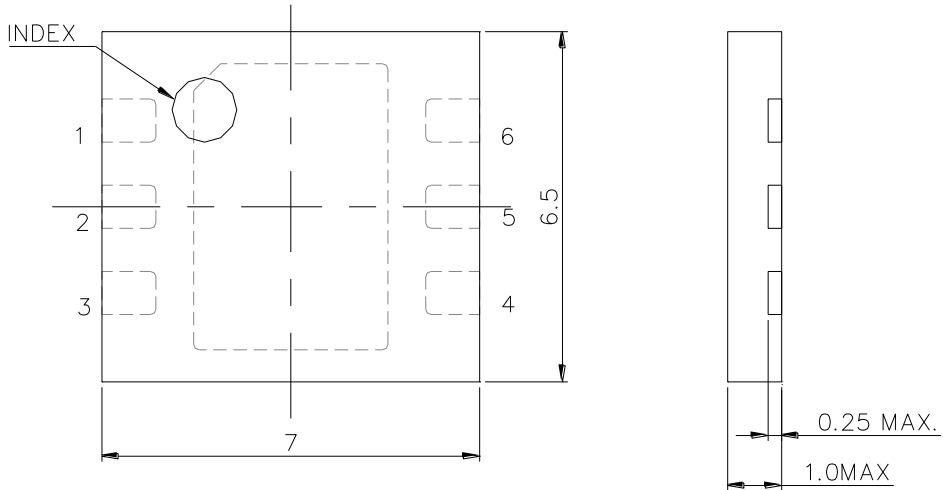
Year	2015	2016	2017	2018	2019	2020	2021	2022	2023
Code	X	Y	Z	A	B	C	D	E	F

Note: Code letter is cycling 25 alphabet without Q.

**Month code**

Month	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Code	H	M	N	P	R	S	T	U	W	X	Y	Z

**Z2D Package Outline  
Full Mold Plastic Package**



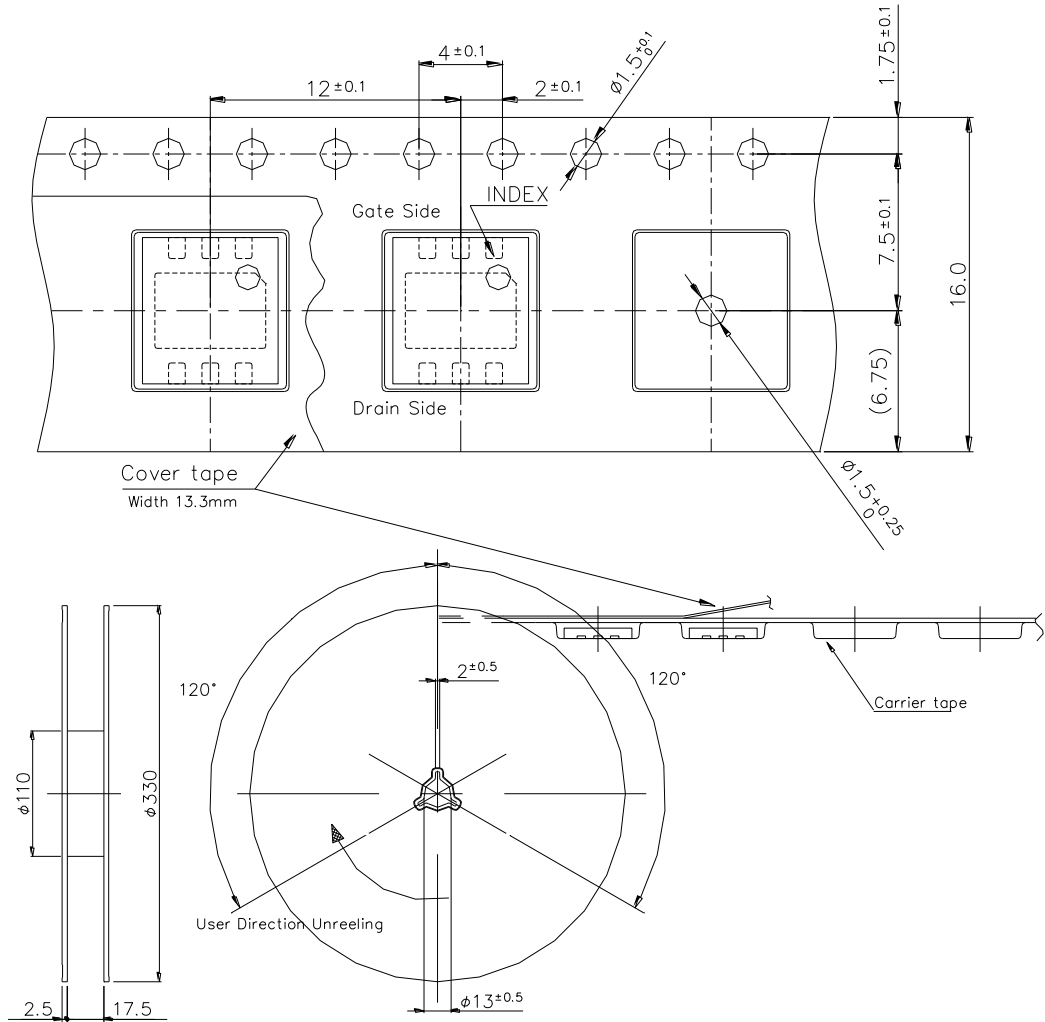
<Twin Type>

- 1 : Gate1
- 2 : NC
- 3 : Gate2
- 4 : Drain2
- 5 : NC
- 6 : Drain1
- 7 : Source

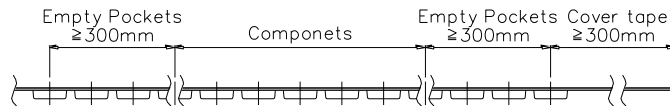
Unit: mm  
Tolerance :  $\pm 0.15\text{mm}$

### Index and Tape / Reel Configuration

(Part Number : SGFCF20T-DT, SGFCF20T-DT1)



(Unit in mm)



Note : Baking of Tape & Reel is possible by following condition.

1. Recommended Baking Condition : 125deg.C, 8hous
2. Upper limit number of times : 5 times

\* Reference standard : JIS standard(JIS C 0806-3)